

#### General Description

The MAX197 evaluation system (EV system) is a complete, low-cost, 8-channel data-acquisition system consisting of a MAX197 evaluation kit (EV kit) and a Maxim 80C32 or 68HC16 microcontroller (μC) module. IBM PC compatible software provides a handy user interface to demonstrate the MAX197's many features. Source code is provided.

The MAX197 EV kit requires a single +5V supply and includes optional input buffer amplifiers that operate with ±15V supplies.

The MAX197 EV kit and EV system evaluate both the MAX197 and the MAX199. To evaluate the MAX199, order a sample of the MAX199 along with the MAX197 EV kit.

#### Features

- **♦ Proven PC Board Layout**
- **♦ Complete Evaluation System**
- **♦** Convenient Test Points Provided On-Board
- ♦ Data Logging Software
- **♦ Source Code Provided**
- **♦ Fully Assembled and Tested**
- ♦ User-Selected Microcontroller Module 80C32 or 68HC16

#### Ordering Information

PART	TEMP. RANGE	BOARD TYPE
MAX197EVKIT-DIP	0°C to +70°C	Through-Hole
MAX197EVC16-DIP	0°C to +70°C	Through-Hole
MAX197EVC32-DIP	0°C to +70°C	Through-Hole

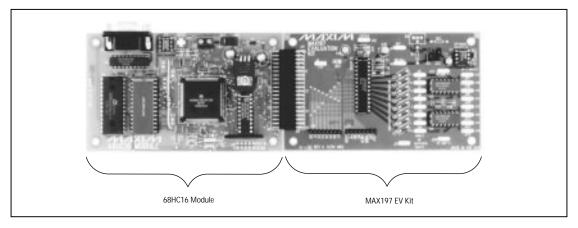
### MAX197 EVC16 System Component List

QTY	DESCRIPTION	
1	MAX197 Evaluation Kit (MAX197EVKIT-DIP)	
1	68HC16 μC Module (68HC16MODULE-DIP)	

#### MAX197 EVC32 System Component List

QTY	DESCRIPTION	
1	MAX197 Evaluation Kit (MAX197EVKIT-DIP)	
1	80C32 μC Module (80C32MODULE-DIP)	

#### MAX197 EVC16 System



MIXIM

Maxim Integrated Products 1

Call toll free 1-800-998-8800 for free samples or literature.

#### \_MAX197 EV Kit Component List

DESIGNATION	QTY	DESCRIPTION
C1, C8, C15, C16, C17	5	0.1µF ceramic capacitors
C2-C7, C9, C12, C13	0	Open
C10, C14, C18	3	10μF tantalum capacitors
C11	1	100pF ceramic capacitor
J11	1	2 x 20 header
J15, J16	2	8-pin headers
JU1	1	2-pin header
JU2	1	3-pin header
JU3, JU4	0	Open
R1, R2, R3	0	Open
U1	1	MAX197BCNI
U2	1	MAX874CPA 4.096V reference
U3, U4	2	MXL1014CN quad op amps

#### MAX197 Stand-Alone EV Kit

The MAX197 EV kit provides a proven PC board layout to facilitate evaluation of the MAX197. It must be interfaced to appropriate timing signals for proper operation. Refer to the MAX197 data sheet for timing requirements

#### \_MAX197 EV System Quick Start

- Copy the files from the distribution disk to your hard disk or to blank floppy disks. The MAX197 EV kit software should be in its own directory. The necessary files are in the root directory of the distribution disk, and the source code is in the SOURCE subdirectory. The SOURCE subdirectory is not required to operate the EV kit.
- 2) Carefully connect the boards together by aligning the 40-pin header of the MAX197 EV kit with the 40pin connector of the µC module. Gently press them together. The two boards should be flush against each other.
- Connect a +15V/-15V DC power supply to the OPAMP V+ / OPAMP V- inputs of the MAX197 EV kit. Connect the power supply's COMMON terminal to the kit's AGND pad.

- 4) Connect a 9V to 15V DC power source to the  $\mu$ C module. The terminal block is located next to the on/off switch, in the upper right corner of the  $\mu$ C module. Observe the polarity marked on the board. The same +15V supply that powers OPAMP V+ can be used to power the  $\mu$ C module.
- 5) Connect a cable from the computer's serial port to the μC module. If using a 9-pin serial port, use a straight-through, 9-pin female-to-male cable. If the only available serial port uses a 25-pin connector, a standard 25-pin to 9-pin adapter will be required. The EV kit software checks the modem status lines (CTS, DSR, DCD) to confirm that the correct port has been selected.
- 6) Start the MAX197 software on the IBM PC by setting the current directory to match the directory that contains the Maxim programs, and then type the program name, "MAX197". Do not turn off or disconnect the μC module while the program is running; if you do, you will have to restart the program.
- 7) The program will ask which μC module is being used and to which port it is connected. Press the space bar until the correct port is highlighted, and press C until the correct μC module is highlighted. Press ENTER when both are correct. The MAX197 program will be in terminal emulation mode.
- 8) Turn on the power for the μC module. The μC module will display its logon banner and test its RAM.
- 9) Download and run the RAM resident program on the μC module by pressing ALT+L (i.e., hold down the ALT key as you strike the L key). The program prompts you for the file name. Press the ENTER key to download and run the file.
- Press ALT+C to switch to the Control Panel screen after the RAM resident program has been successfully downloaded.
- 11) Apply input signals to the CH0-CH7 inputs at the right edge of the MAX197 EV kit board. Observe the readout on the screen. Table 1 lists the commands available from the control-panel screen.
- Before turning off power to the MAX197 EV kit, exit the program by pressing ALT+X.

## \_Detailed Description of Software

#### Reading the MAX197

The EV kit reads the MAX197 using the algorithm shown in source code Listings 1a and 1b.

When power is first applied, the MAX197 is in external clock mode. However, the initialization software reconfigures the MAX197 to internal clock mode.

The EV kit software demonstrates the MAX197's many modes of operation. When writing your own application-specific software, one of the following simplified algorithms (shown in bold type) should be implemented. These algorithms show the options available using the power-down and acquisition mode control bits. Except where otherwise specified, ACQMOD = 0.

When using an external reference, a power-up delay is not necessary. When using the MAX197's internal reference, allow time for the REF capacitor to charge at power-up and when exiting full power-down mode. For a complete description of all control bits, refer to the MAX197 data sheet.

# Internal acquisition mode, standby power-down between conversions:

- Begin conversion by writing PD1 = 1, PD0 = 0. This powers up the MAX197, causing it to perform a conversion, then go into standby mode after conversion completes.
- After the INT pin goes low, read the result from the MAX197.

## Internal acquisition mode, full power-down between conversions:

- 1) Power up the MAX197 by writing PD1 = 1, PD0 = 0 (standby).
- Execute a power-up delay, to allow the reference capacitor time to recharge.
- 3) Begin conversion by writing PD1 = 1, PD0 = 1 (full power-down).
- After the INT pin goes low, read the result from the MAX197

# Internal acquisition mode, $\overline{\text{SHDN}}$ pin low between conversions:

- 1) Power up the MAX197 by setting the SHDN pin high.
- 2) Execute a power-up delay to allow the reference capacitor time to recharge.

- Begin conversion by writing PD1 = 1, PD0 = 0 (standby).
- After the INT pin goes low, read the 16-bit result from the MAX197.
- 5) Power down the MAX197 by setting the SHDN pin

# External acquisition mode, standby power-down between conversions:

- Begin acquisition time by writing PD1 = 1, PD0 = 0 (standby), ACQMOD = 1.
- 2) Execute the acquisition time delay.
- Begin conversion by writing PD1 = 1, PD0 = 0 (standby), ACQMOD = 0.
- After the INT pin goes low, read the result from the MAX197.

# External acquisition mode, full power-down between conversions:

- Power up the MAX197 by writing PD1 = 1, PD0 = 0 (standby).
- Execute a power-up delay, to allow the reference capacitor time to recharge.
- Begin acquisition time by writing PD1 = 1, PD0 = 0 (standby), ACQMOD = 1.
- 4) Execute the acquisition time delay.
- 5) Begin conversion by writing PD1 = 1, PD0 = 1 (full power-down), ACQMOD = 0.
- After the INT pin goes low, read the result from the MAX197.

# External acquisition mode, SHDN pin low between conversions:

- Power up the MAX197 by setting the SHDN pin high.
- Execute a power-up delay, to allow the reference capacitor time to recharge.
- Begin acquisition time by writing PD1 = 1, PD0 = 0 (standby), ACQMOD = 1.
- 4) Execute the acquisition time delay.
- Begin conversion by writing PD1 = 1, PD0 = 0 (standby), ACQMOD = 0.
- After the INT pin goes low, read the result from the MAX197.
- Power down the MAX197 by setting the SHDN pin low.

#### Listing 1a. Using the 68HC16 to Read the MAX197

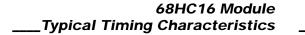
```
Index register X points to the MAX197 address
Index register Y points to global variables area
MAX197 INT pin inputs to IC1 of the GPT port
MAX197 SHDN pin is driven by OC1 of the GPT port (or else it should be tied high)
                                            ; point index X to the MAX197's address ; ($07E000 on the Maxim 68HC16 Module)
F507
379C
                           ldx #$E000
37BC E000
                ; optional -- set SHDN pin high
                          bset $F907,#8
3908 F907
                ; optional power-up delay
                          at power-up detay
lde _power_up_delay,y
ldd _control word,y
andb #$3F ; clear PD1,PD0
orab #$80 ; set PD1
3755 000C
                                                                             out ((control_word & ~ 0xCO) | 0x80);
3705 0006
F63F
F780
CA00
                           stab 0,X
27FB
                           ted
                                                                             delay (power_up_delay);
                           jsr delay
FAXX XXXX
                ; optional software-controlled acquisition time
                          lde _acq_delay,y
ldd _control_word,y
andb #$3F ; clear PD1,PD0
orab #$A0 ; set PD1,ACQMOD
3755 000E
3705 0006
                                                                             out ((control_word &~ 0xCO) | 0xAO);
F63F
F7A0
                           stab 0,X
CAOO
27FB
                                                                             delay (acq_delay);
                           ted
FAXX XXXX
                           jsr delay
                ; start the conversion by writing the control word to the {\tt MAX197}
3705 0006
                          ldd _control_word,y
stab 0,X
CAOO
                                                                      ; out (control_word);
                ; poll the INT pin until the MAX197 conversion is complete while1: ; while (INT pin is high) (
                           brclr $F907,#1,whilex1
3A01 F907
0014
37B5 55AA
177A FA27
                           ldd #$55AA
                                            ; reset software watchdog timer
                           staa swsr
17FA FA27
                           stab swsr
1775 FC0D
                           ldaa scsr+1
                                                                                if (serial_character_received()) break;
7640
                           anda #$40
B7E2
                           beq while1
                whilex1:
                ; optional -- bring SHDN pin low
ldd _using_shdn_pin,y
cmpb #0
3705 000A
                                                                      ; if (using_shdn_pin) {
F800
                           beq ifelse4
bclr $F907,#8
B700
3808 F907
                                                                             clearbit(SHDN pin);
                                                                      ; }
                ifelse4:
                ; read data word from MAX197
ldd 0,X
                                                                       ; read word from MAX197
8500
371A
37DA 0008
                                                                       ; swap low and high words
                           xgab
                           std _last_word_read,y
```

4 \_\_\_\_\_\_ NIXIN

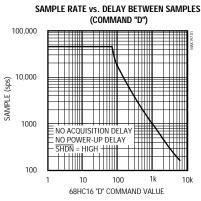
Listing 1b. Using the 80C32 to Read the MAX197

```
Assumptions:
                                 MAX197 maps to address COOO (low byte) and COO1 (high byte)
MAX197 INT pin inputs to P1.0
MAX197 SHDN pin is driven by P1.3 (or else it should be tied high)
                                ; global variables are in internal RAM
                               SHDNPIN equ P1.3
INTPIN equ P1.0
=0093#
=0090#
                               ; optional -- set SHDN pin high
                                          setb SHDNPIN
                               ; optional power-up delay
mov a, control_word
anl a,#03Fh ; clear PD1,PD0
orl a,#080h ; set PD1
                                                                                        out ((control_word & ~ 0xCO) | 0x80);
E5 24
54 3F
44 80
90 C000
                                          mov dptr,#0C000h
movx @dptr,a
FΟ
AA 29
                                          mov r2,_power_up_delay_l
                                                                                         delay (power_up_delay);
AB 2A
                                          mov r3, power up delay h
                               delay_loopp:
С3
                                          mov a,r2
subb a,#09h
FΑ
94 09
                                          mov r2,a
                                          mov a,r3
subb a,#00h
mov r3,a
ΕB
94 00
50 F5'
                                          jnc delay_loopp
                               ; optional software-controlled acquisition time
                                          mov a, control_word
anl a,#03Fh; clear PD1,PD0
orl a,#0A0h; set PD1,ACQMOD
E5 24
                                                                                        out ((control_word & ~ 0xCO) | 0xAO);
54 3F
44 A0
90 C000
                                          mov dptr,#0C000h
FΟ
                                          movx adptr,a
                                          mov a,_acq_delay
mov r5,a
inc r5
E5 2B
FD
                               delay_loopa:
DD FE'
                                          DJNZ r5,delay_loopa
                                                                                        delay (acq delay);
                               ; start the conversion by writing the control word to the {\tt MAX197}
                                          mov a,_control_word
mov dptr,#0c000h
E5 24
90 C000
                                                                                  ; out (control_word)
                                          movx adptr,a
                               ; poll the INT pin until the MAX197 conversion is complete
                                                                                    ; while (INT is high) {
30 90# 03:
                               jnb RI,while1 whilex1:
                                          jnb INTPIN,whilex1
                                                                                          if (keypressed()) break;
30 98# FA'
                               ; optional -- bring SHDN pin low
C2 93
                                          clr SHDNPIN
                               ; read data word from MAX197
90 C000
                                          mov dptr,#0C000h
                                          movx a,@dptr
mov _last_word_read_l,a
mov dptr,#0C001h
ΕO
F5 26
90 C001
                                          movx a adptr
E5 27
                                          mov _last_word_read_h,a
```

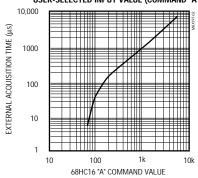
NIXIN



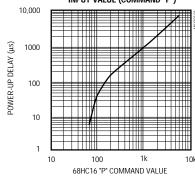
## 80C32 Module Typical Timing Characteristics



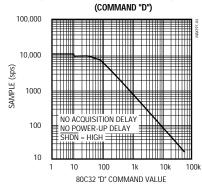




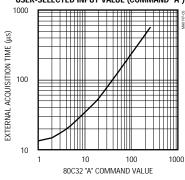
POWER-UP DELAY vs. USER-SELECTED INPUT VALUE (COMMAND "P")



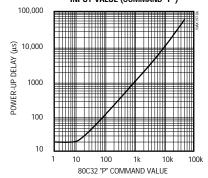
## SAMPLE RATE vs. DELAY BETWEEN SAMPLES



# EXTERNAL ACQUISITION TIME vs. USER-SELECTED INPUT VALUE (COMMAND "A")



# POWER-UP DELAY vs. USER-SELECTED INPUT VALUE (COMMAND "P")



#### Shutdown Power Cycling

From the control panel, use the up/down arrow keys to select the power-down mode. STANDBY power cycling puts the MAX197 in standby mode between readings, and FULLPD turns off everything except the 2.5V bandgap reference. The MAX197 is always fully powered during conversions. The MAX197's shutdown pin can be used to put the device into FULLPD mode. When using FULLPD or SHDN, a power-up delay may be necessary to allow the reference buffer time to recharge. From the control panel, use the "P" command to set this power-on delay. The 68HC16 software allows delays between 68µs and 6000µs. The 80C32 software allows delays between 8µs and 65535µs. A value of 0 disables the delay. Refer to the Typical Timing Characteristics to see the relationship between the value selected on the corresponding power-up delay.

#### Low-Speed Data Logging

The RS-232 serial link limits the data logging sample rate to no more than 10sps (samples per second). The data logging command can be used to write data to a user-specified file in plain comma-spaced-value text format. From the control panel screen, press L. If a log file is not already open, the software will ask for a file name. Only one log file is allowed per session. Once a log file has been opened, pressing L toggles data logging on or off. While data logging is enabled, the word "Logging" will flash on the screen. One complete line of data is written to the log file after all enabled channels have been sampled.

The first line of the log file contains the column headings. Each subsequent line of the log file contains all eight channels, separated by commas. The values are written as raw decimal output codes or as scaled voltages, depending on which setting the control panel is currently displaying. Use the C and V commands to select the display format (see Table 1). F3, the log data marker command, can be used to sequentially tag different sections of the log file to indicate a change in setup or input conditions. Pressing F3 writes an extra entry at the end of the current line of the data log, which can be useful for indicating a change in setup or input conditions.

#### **High-Speed Data Sampling**

For sampling rates over 10sps, the S command can be used. Data can be collected from only one of the eight channels at a rate from 100sps up to 45ksps for the 68HC16 module (10sps to 10ksps for the 80C32 module). First, select the channel by pressing one of the number keys 0–7. Next, press F to specify the name of the file into which the samples should be written. If the file already exists, the screen will say "\*\*\* file already exists\*\*\*". To begin collecting data, press B. After 1024 samples have been collected, the data is automatically uploaded to the host and stored in the sample file.

#### **Controlling the Sampling Rate**

The rate for high-speed sampling, data logging, and the oscilloscope demo mode (see Table 1, key "O") is controlled by the D (delay between samples) command.

When used with the sample or oscilloscope demo commands, specify the approximate delay in microseconds by typing D, the approximate delay time, then "usec". Refer to the *Typical Timing Characteristics* to see the relationship between the value selected and the corresponding delay between samples. Due to code overhead, this delay is not perfectly linear, so timing should always be verified using an oscilloscope. The fast sampling screen and oscilloscope demo mode use delays on the order of 100µs to 1000µs. The 80C32 software supports delays between 24µs and 73ms, but the 68HC16 software only supports delays between 68µs and 6000µs.

When used with the slower data-logging command, specify the delay in seconds. This delay is defined as the time between two consecutive conversions.

#### Tare Command (software offset null)

The tare command is used to compensate in software for the offset voltage. Connect the channel 0 input pin to ground (or, if driving with an op amp, connect the channel 0 op amp's input to ground instead). The "T" command measures the offset voltage on channel 0 and subtracts that offset from all subsequent readings on all channels. The tare command is canceled by pressing CTRL+T.

#### \_Detailed Description of Hardware

#### Driving the Analog Inputs

Select an op amp based on its settling time. A fast settling time is more important than a fast slew rate. Sites U3 and U4 on the EV kit are industry-standard quad op-amp pinouts in the voltage-follower configuration. When using a slow op amp, extend the acquisition time by using the "A" command in the control panel. The 68HC16 software allows acquisition times between 68µs and 6000µs. The 80C32 software allows acquisition times between 12µs and 560µs. A value of 0 disables the delay.

For high sampling rates, a fast settling op amp such as Maxim's MXL1014 performs quite well. Refer to the *Typical Timing Characteristics* to see the relationship between the value selected and the corresponding external acquisition delay. For lower sampling rates, any quad 741 type op amp should be adequate. The LM348 is an inexpensive solution. For +5V single-supply systems, the MAX414 is recommended.

#### Changing the Reference Voltage

The MAX197 can use either its internal reference or an external reference. On the EV kit, the internal reference has been disabled by pulling the REFADJ pin up to +5V (JU1) and driving the REF pin with a MAX874 4.096V reference (JU2).

When driving the REF pin with an external reference, install a shunt at JU1 and place JU2 in the 1-2 position. When driving the REFADJ pin with an external reference, leave jumper JU1 open and place JU2 in the 2-3 position.

For lowest component count, the MAX197's internal reference can be enabled by removing the shunts from JU1 and JU2. This enables the internal bandgap reference and the reference buffer, driving REF internally to 4.096V. For best results, install a  $0.01\mu F$  ceramic bypass capacitor near the REFADJ pin (C7 on the EV kit).

The MAX197 EV kit software assumes a 4.096V reference voltage, unless otherwise specified. When using other reference values, the reference value must be specified when starting the program. For example, if the REFADJ pin is driven by a 2.048V reference, start the MAX197 software by typing:

#### MAX197 REFADJ 2.048

Or, if the REFADJ pin is pulled high and REF is driven by a 3.00V reference, start the MAX197 software by typing:

#### MAX197 REF 3.00

#### Using an External Clock

Cut JU4 open. From the control panel, press F8 to select external clock mode. Apply the external clock to the EXTCLK input pad.

#### **Evaluating the MAX199**

To evaluate the MAX199 using the MAX197 EV kit, replace U1 with a MAX199. Then, at the DOS prompt, start the MAX197 software by typing:

#### MAX197 199

If the voltage reference is different than the default 4.096V, the MAX197 EV kit software should be informed. For example, if the REFADJ pin is driven by a 2.048V reference, start the MAX197 software by typing:

#### MAX197 199 REFADJ 2.048

Or, if the REFADJ pin is pulled high and REF is driven by a 3.00V reference, start the MAX197 software by typing:

#### MAX197 199 REF 3.00

Refer to the *Changing the Reference Voltage* section for an explanation of how REF and REFADJ interact.

Table 1. MAX197 EV Kit Commands

KEY	FUNCTION
F1	Choose input scale (bipolar 10V, unipolar 10V, bipolar 5V, unipolar 5V). The currently active scale is shown underneath the bar-graph display.
0–7	Enable or disable the corresponding input channel 0, 1, 2, 3, 4, 5, 6, or 7. The EV kit software scans all selected channels.
С	Display the input codes in decimal.
V	Display the input voltages.
D	Delay between samples. Delays longer than one second are handled by the IBM PC; otherwise, the $\mu$ C module handles the delay. Timing is approximate and should be verified with an oscilloscope.
↑,↓	Select standby, fast power-down, SHDN power-down, or no power-down.
Р	Power-up delay. Timing is approximate and should be verified with an oscilloscope. Power-up delay is used regardless of which power-cycling mode is selected. In standby mode, power-up delay is not necessary and should be set to zero.
А	External acquisition time for use with slow op amps. Timing is approximate and should be verified with an oscilloscope. The MAX197 is placed in standby mode during acquisition time.
F7	Internal clock mode. Timing is controlled by capacitor C11. JU4 should be closed when using this mode.
F8	External clock mode. Clock must be provided at EXTCLK input pad. JU4 should be cut apart when using this mode.
О	Oscilloscope demo. Samples are collected and discarded as fast as possible. Observe waveforms and timing with an oscilloscope.
S	Sample one of the eight inputs at high speed and upload to a user-specified file. The sampling rate is controlled by the P, A, and D delays. Due to program overhead, the O and S commands operate at different rates. Timing should be verified with an oscilloscope.
Т	Tare (offset voltage null). Assumes that channel 0 is connected to AGND. Measures the code at channel 0 and subtracts that value from all subsequent readings.
CTRL+T	Cancel the Tare (T) function.
L	Enable or disable data logging. If the -L command line option is not specified, the L command prompts for a log file name.
F3	Write a marker into the data log file. (See the Low-Speed Data Logging section.)
ALT+T	Switch back to terminal mode.
ALT+X	Exit to DOS.

MIXIN

# Evaluates: MAX197/MAX199

# **MAX197 Evaluation Kit**

# Table 2. Command-Line Options when Starting MAX197 Software

COMMAND	FUNCTION	
1	Default to COM1 part of the PC.	
2	Default to COM2 part of the PC.	
MONO	For use with monochrome or LCD display.	
-Lfilename	Open file "filename" for data logging, and enable the data-logging commands.	
REF vvv	Specify the voltage at the REF pin (nominally 4.096V). Note that REF is an input or an output, depending on the state of the REFADJ pin. Refer to the MAX197 data sheet.	
REFADJ vvv	Specify the voltage at the REFADJ pin (nominally 2.5V).	
199	Interprets the output codes for a MAX199 instead of a MAX197. Refer to the MAX199 data sheet.	

# Table 3. Jumper Settings on MAX197 EV Kit

JUMPER	STATE	FUNCTION
JU1	closed	(Default) Disable internal bandgap reference; REF pin is an input.
	open	Enable internal bandgap reference; REF pin is 4.096V output.
JU2	1-2	(Default) Connects external 4.096V reference (MAX874) to REF pin; JU1 must be closed.
	2-3	Connects external reference to REFADJ pin.
	open	REF = 4.096V output and REFADJ = 2.5V output (internal reference)
JU3	closed	(Default Trace) Current-sense jumper. The MAX197 draws its +5V supply through this trace.
	open	Do not operate kit with JU3 open.
JU4	closed	(Default Trace) Use C11 as the timing capacitor for the MAX197 internal clock mode.
	open	Use the EXTCLK input pad as clock input.

0 \_\_\_\_\_\_M/XI/M

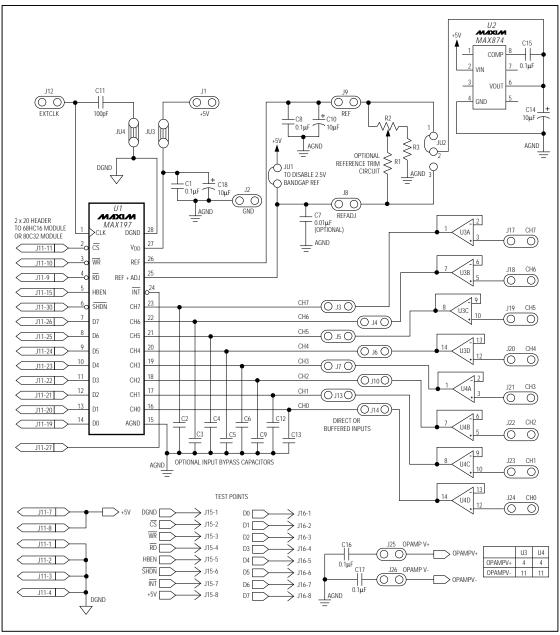


Figure 1. MAX197 EV Kit Schematic

NIXIN

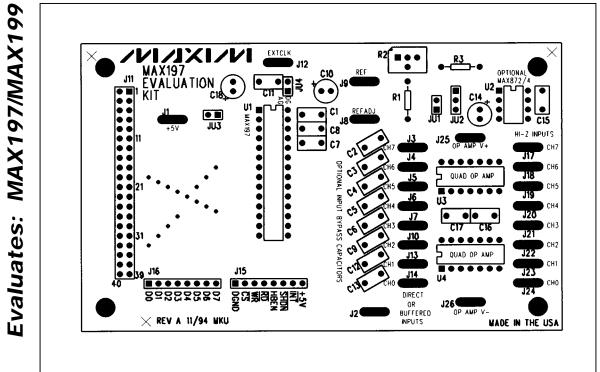


Figure 2. MAX197 EV Kit Component Placement Guide

12

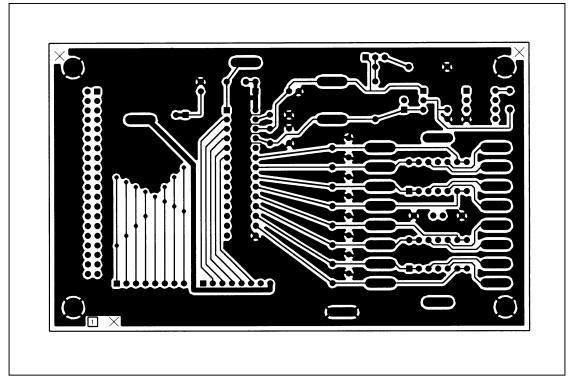


Figure 3. MAX197 EV Kit PC Board Layout—Component Side

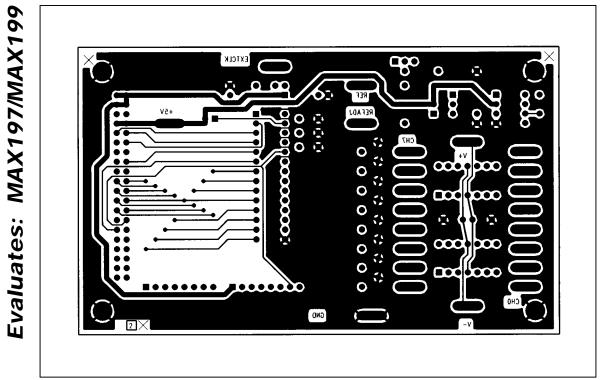


Figure 4. MAX197 EV Kit PC Board Layout—Solder Side

MIXIM